



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	IP1120N04S4-01	<b>Issued</b>	18. August 2021
<b>MA#</b>	MA005578280		
<b>Package</b>	PG-TO262-3-1	<b>Weight*</b>	1577.47 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	6.481	0.41	0.41	4109	4109
leadframe	inorganic material	phosphorus	7723-14-0	0.255	0.02		162	
	non noble metal	iron	7439-89-6	0.851	0.05		539	
	non noble metal	copper	7440-50-8	849.682	53.87	53.94	538637	539338
wire	non noble metal	aluminium	7429-90-5	12.320	0.78	0.78	7810	7810
encapsulation	inorganic material	zinc oxide	1314-13-2	5.814	0.37		3686	
	miscellaneous	miscellaneous	-	23.257	1.47		14744	
	plastics	epoxy resin	-	87.215	5.53		55288	
	inorganic material	silicon dioxide	60676-86-0	465.149	29.49	36.86	294871	368589
lead finish	non noble metal	tin	7440-31-5	15.198	0.96	0.96	9634	9634
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.228	0.01	0.01	145	146
solder	non noble metal	tin	7440-31-5	0.093	0.01		59	
	noble metal	silver	7440-22-4	0.117	0.01		74	
	non noble metal	lead	7439-92-1	4.455	0.28	0.30	2824	2957
heatspreader	inorganic material	phosphorus	7723-14-0	0.032			20	
	non noble metal	iron	7439-89-6	0.106	0.01		67	
	non noble metal	copper	7440-50-8	106.210	6.73	6.74	67330	67417
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com